UNA06R180M

Advance

POWER MOSFET

TO-220

35A, 60V N-CHANNEL **ENHANCEMENT MODE** TRENCH POWER MOSFET

DESCRIPTION

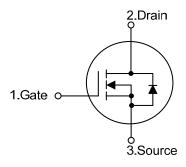
The UTC UNA06R180M is an N-channel Power MOSFET, it uses UTC's advanced technology to provide the customers with high switching speed and low on-state resistance, etc.

The UTC UNA06R180M is suitable for boost converters and synchronous rectifiers for consumer, telecom, industrial power supplies and LED, etc.

FEATURES

- * $R_{DS(ON)}$ < 18m Ω @ V_{GS} =10V, I_{D} =30A
- * High power and current handling capability
- * High speed switching
- * Low gate charge

SYMBOL



ORDERING INFORMATION

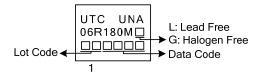
Ordering	Dookogo	Pin Assignment			Dooking		
Lead Free	Halogen Free	Package	1	2	3	Packing	
UNA06R180ML-TA3-T	UNA06R180MG-TA3-T	TO-220	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source UNA06R180ML-TA3-R



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MARKING





■ **ABSOLUTE MAXIMUM RATING** (T_A =25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{ extsf{DSS}}$	60	V	
Gate-Source Voltage		V_{GSS}	±20	V	
Drain Current	Continuous (Note 2)	T _C =25°C	I _D	35	Α
		T _C =100°C		27	Α
		T _A =25°C		7	Α
		T _A =70°C		6	Α
	Pulsed(Note 3)		I _{DM}	120	Α
Avalanche Current	Avalanche Current		I _{AS}	26	Α
Avalanche Energy (Note4)		E _{AS}	101	mJ	
Power Dissipation		T _C =25°C	P _D	100	W
		T _C =100°C		50	W
		T _A =25°C		2.1	W
		T _A =70°C		1.3	W
Junction Temperature		TJ	150	°C	
Storage Temperature Range		T _{STG}	-55~+150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Current limited by bond wire.
- 3. Repetitive rating: Pulse width limited by maximum junction temperature.
- 4. L=0.3mH, I_{AS} =26A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 5. $I_{SD} \le 26A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 175$ °C

■ THERMAL RESISTANCES CHARACTERISTICS

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to ambient	steady state	θ_{JA}	60	°C/W
Junction to Case	steady state	θ_{JC}	1.5	°C/W



■ **ELECTRICAL CHARACTERISTICS** (T_A =25°C, unless otherwise specified)

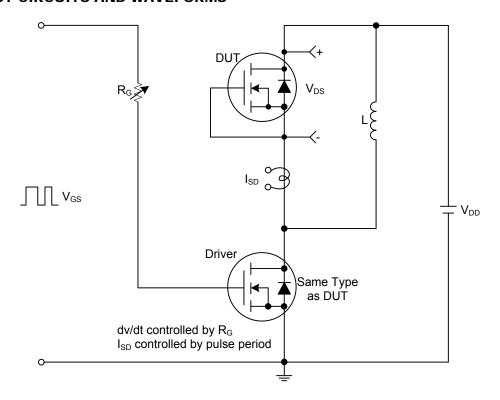
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$	60			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =60V, V _{GS} =0V			1	μΑ
			V _{DS} =60V, T _J =55°C			5	μΑ
Gate-Source Leakage Current	orward	I _{GSS}	V _{GS} =+20V, V _{DS} =0V			+100	nA
	leverse		V _{GS} =-20V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.0		3.0	V
Static Drain-Source On-State R (Note 1)	esistance	R _{DS(ON)}	V _{GS} =10V, I _D =30A		15	18	mΩ
Forward Transconductance(Note 1	Forward Transconductance(Note 1)		V _{DD} =5V, I _D =30A		50		S
DYNAMIC PARAMETERS		g fs					
Input Capacitance	nput Capacitance				1840		pF
Output Capacitance Reverse Transfer Capacitance		Coss	V _{GS} =0V, V _{DS} =30V, f=1.0MHz		185		pF
		C_{RSS}			80		pF
Gate resistance		Rg	V _{GS} =0V, V _{DS} =0V, f=1MHz		3	5	Ω
SWITCHING PARAMETERS							
Total Gate Charge		Q_G	\\ -E0\\ \\ -10\\ -1.3A		27.5		nC
Gate to Source Charge		Q_GS	V _{DS} =50V, V _{GS} =10V, I _D =1.3A		10		nC
Gate to Drain Charge		Q_GD	(Note 1, 2)		6.5		nC
Turn-on Delay Time		$t_{D(ON)}$			12		ns
Rise Time	-		$V_{DD} = 30V$, $I_D = 0.5A$, $R_G = 25\Omega$		5.2		ns
Turn-off Delay Time			(Note 1, 2)		38		ns
Fall-Time		t _F			27		ns
SOURCE- DRAIN DIODE RATING	S AND C	HARACTER	STICS				
Maximum Body-Diode Continuous Current		Is	Integral p-n diode in MOSFET			35	Α
Maximum Body-Diode Pulsed Curr	ent	I _{SM}	integral p-11 diode in WOSFET			140	Α
Drain-Source Diode Forward Volta	ge	V_{SD}	I _S =1A, V _{GS} =0V	0.75		1.0	V
Body Diode Reverse Recovery Tin	пе	t_{RR}	 - s=30A, dls/dt=100A/µs		35		ns
Body Diode Reverse Recovery Charge		Q_{RR}	15-50Δ, αιζ/αι-100Α/μ5		47		nC

Notes: 1. Pulse test: pulse width ≤ 300us, duty cycle ≤ 2%.

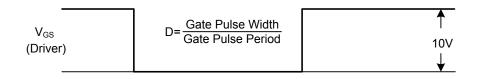


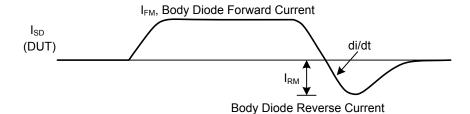
^{2.} Essentially independent of operating temperature.

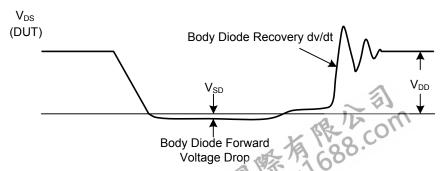
■ TEST CIRCUITS AND WAVEFORMS



Peak Diode Recovery dv/dt Test Circuit



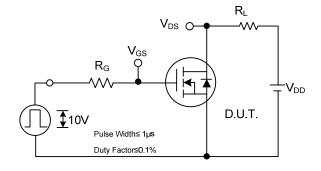


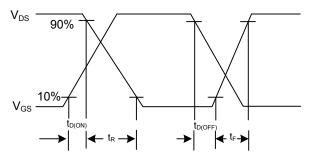


Peak Diode Recovery dv/dt Test Circuit and Waveforms

Peak Diode Recovery dv/dt Waveforms

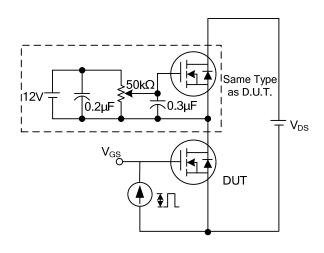
TEST CIRCUITS AND WAVEFORMS

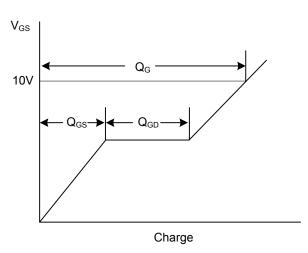




Switching Test Circuit

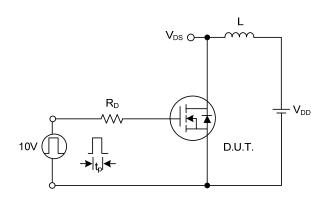
Switching Waveforms

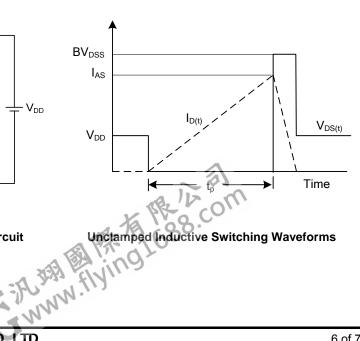




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

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